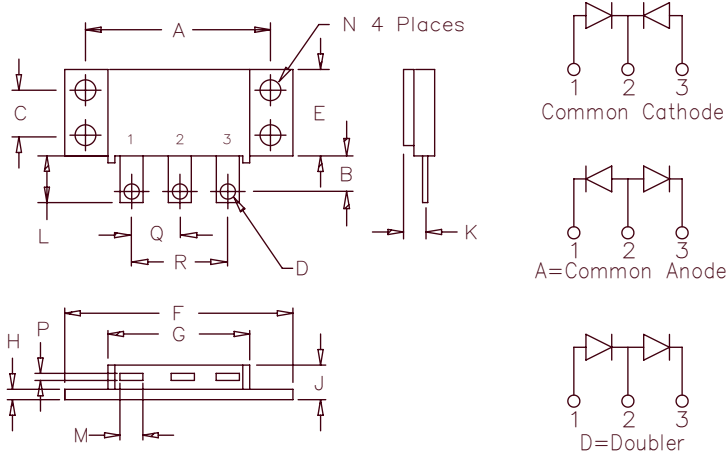


Schottky Powermod FST16230



Notes:
Baseplate: Nickel plated copper;
electrically isolated
Pins: Nickel plated copper

Dim.	Inches		Millimeters		Notes
	Min.	Max.	Min.	Max.	
A	1.995	2.005	50.67	50.93	
B	0.300	0.325	7.62	8.26	
C	0.495	0.505	12.57	12.83	
D	0.182	0.192	4.62	4.88	Dia.
E	0.990	1.010	25.15	25.65	
F	2.390	2.410	60.71	61.21	
G	1.500	1.525	38.10	38.70	
H	0.120	0.130	3.05	3.30	
J	---	0.400	---	10.16	
K	0.240	0.260	6.10	6.60 to Lead Q	
L	0.490	0.510	12.45	12.95	
M	0.330	0.350	8.38	6.90	
N	0.175	0.195	4.45	4.95	Dia.
P	0.035	0.045	0.89	1.14	
Q	0.445	0.455	11.30	11.56	
R	0.890	0.910	22.61	23.11	

TO-249

Microsemi Catalog Number	Industry Part Number	Working Peak Reverse Voltage	Repetitive Peak Reverse Voltage
FST16230*	162CMQ030	30V	30V

*Add the Suffix A for Common Anode, D for Doubler

- Schottky Barrier Rectifier
- Guard Ring for Reverse Protection
- $V_{RRM} = 30$ Volts
- High Surge Capacity
- Reverse Energy Tested
- ROHS Compliant

Electrical Characteristics

Average forward current per pkg	$I_{F(AV)}$ 160 Amps	$T_C = 83^\circ\text{C}$, Square wave, $R_{\theta JC} = 0.5^\circ\text{C/W}$
Average forward current per leg	$I_{F(AV)}$ 80 Amps	$T_C = 83^\circ\text{C}$, Square wave, $R_{\theta JC} = 1.0^\circ\text{C/W}$
Maximum surge current per leg	I_{FSM} 1000 Amps	8.3 ms, half sine $T_J = 150^\circ\text{C}$
Max repetitive peak reverse current per leg	$R(OV)$ 2 Amps	$f = 1$ KHz, 25°C , $1\mu\text{sec}$ Square wave
Max peak forward voltage per leg	V_{FM} .55 Volts	$I_{FM} = 80\text{A}$: $T_J = 125^\circ\text{C}^*$
Max peak forward voltage per leg	V_{FM} .59 Volts	$I_{FM} = 80\text{A}$: $T_J = 25^\circ\text{C}^*$
Max peak reverse current per leg	I_{RM} 300 mA	V_{RRM} , $T_J = 125^\circ\text{C}^*$
Max peak reverse current per leg	I_{RM} 1 mA	V_{RRM} , $T_J = 25^\circ\text{C}$
Typical junction capacitance per leg	C_J 2400 pF	$V_R = 5.0\text{V}$, $T_J = 25^\circ\text{C}$

*Pulse test: Pulse width 300 μsec , Duty cycle 2%

Thermal and Mechanical Characteristics

Storage temp range	T_{STG}	-55°C to 175°C
Operating junction temp range	T_J	-55°C to 150°C
Maximum thermal resistance per leg	$R_{\theta JC}$	1.0°C/W Junction to case
Maximum thermal resistance per pkg.	$R_{\theta JC}$	0.5°C/W Junction to case
Typical thermal resistance (greased)	$R_{\theta CS}$	0.1°C/W Case to sink
Mounting torque		15 – 20 inch pounds
Weight		2.5 ounces (71 grams) typical

FST16230

Figure 1
Typical Forward Characteristics – Per Leg

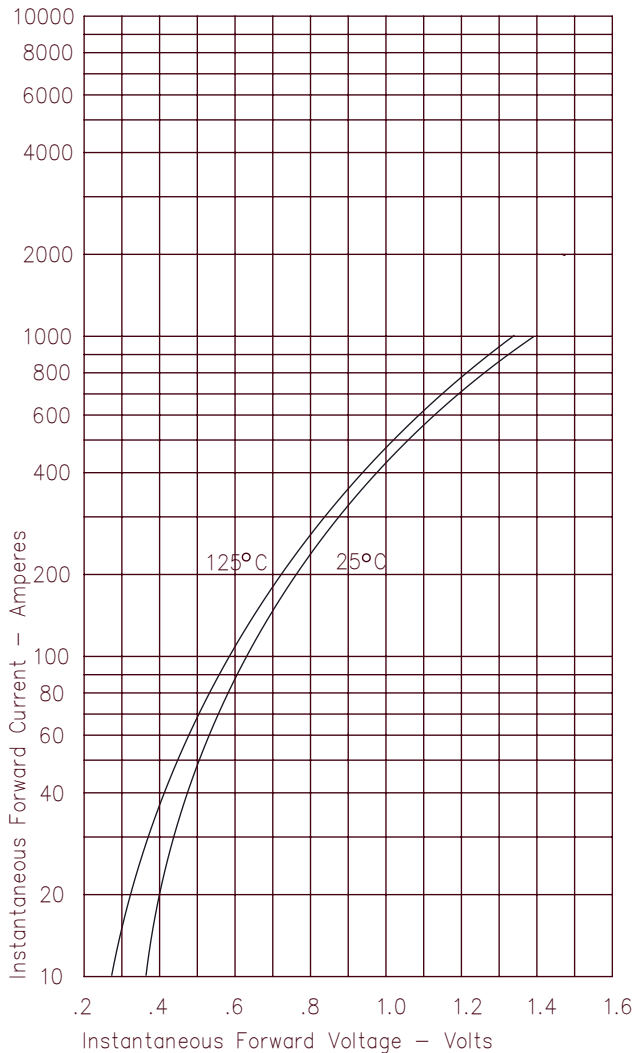


Figure 3
Typical Junction Capacitance – Per Leg

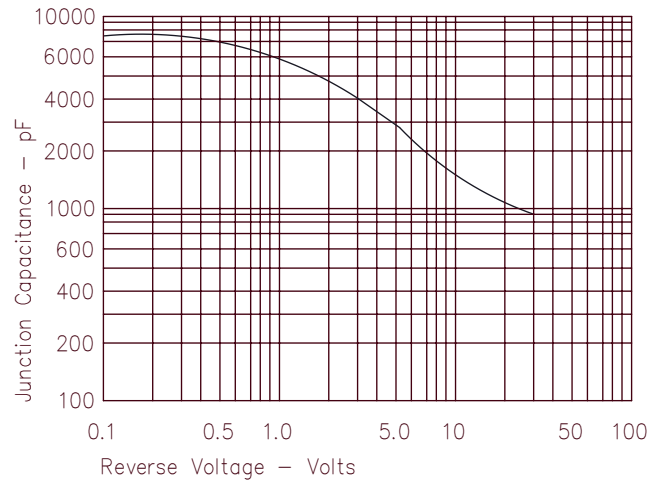


Figure 4
Forward Current Derating – Per Leg

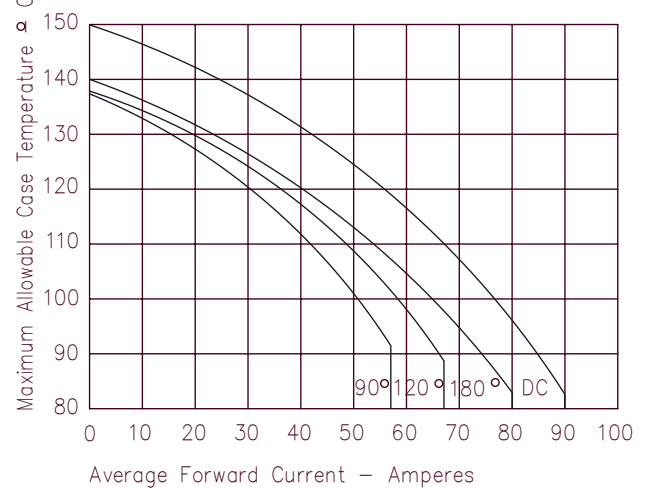
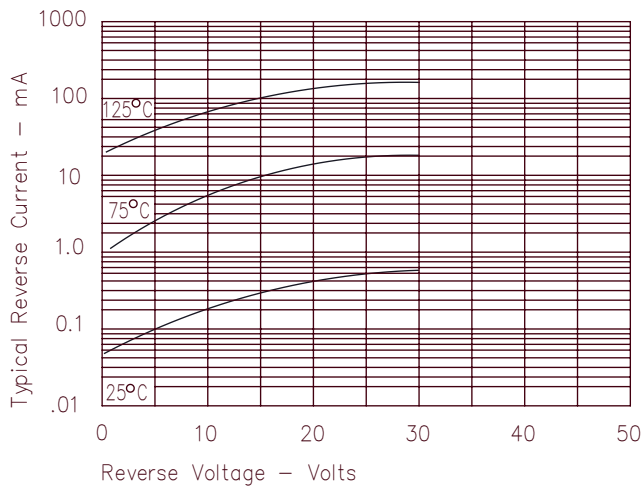


Figure 2
Typical Reverse Characteristics – Per Leg



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